

# **SPECIFICATION**

# 宏致電子股份有限公司

桃園縣中壢市東園路13號

No.13, Dongyuan Rd., Jhongli City,

Taoyuan County 320, Taiwan (R.O.C.)

TEL: +886-3-463-2808 FAX: +886-3-463-1800

SPEC. NO.: PS-31120-XXXXX-XXX REVISION: B

PRODUCT NAME: USB 3.0 A TYPE

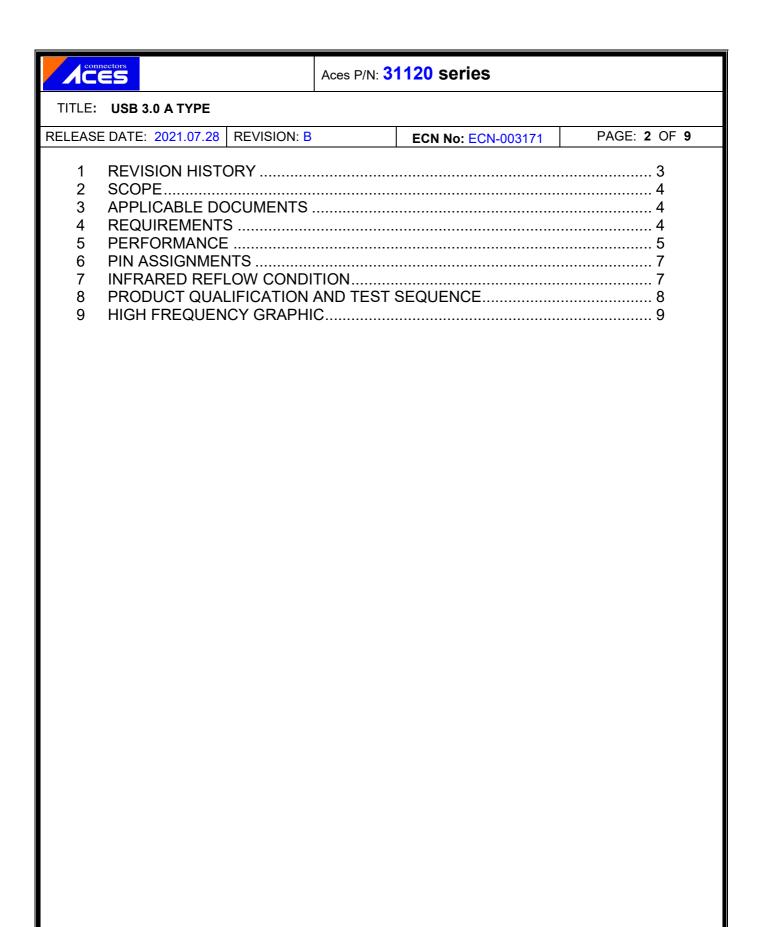
**PRODUCT NO:** 31120 \cdot 30201 \cdot 30154 \cdot 30173 \cdot 301xx SERIES

PREPARED: CHECKED: APPROVED:

LIAO WAN TING | TENG CHANG HO | KUO JUNG HSUN

DATE: DATE:

2021.07.28 2021.07.28 2021.07.28



I connectors

Aces P/N: 31120 series

TITLE: USB 3.0 A TYPE

RELEASE DATE: 2021.07.28 REVISION: B **ECN No:** ECN-003171 PAGE: **3** OF **9** 

## 1 Revision History

Rev.	ECN#	Revision Description	Prepared	Date		
Α	ECN-002602	NEW SPEC	LIAO WAN TING	2021/02/26		
В	ECN-003171	ADD 30173 · 301xx SERIES	LIAO WAN TING	2021/07/28		



TITLE: USB 3.0 A TYPE

RELEASE DATE: 2021.07.28 | REVISION: B | ECN No: ECN-003171 | PAGE: 4 OF 9

#### 2 SCOPE

This specification covers performance, tests and quality requirements for USB 3.0 connector.

#### 3 APPLICABLE DOCUMENTS

**EIA-364**: **ELECTRONICS INDUSTRIES ASSOCIATION** 

#### **4 REQUIREMENTS**

- 4.1 Design and Construction
  - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
  - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
  - 4.2.1 Contact: High performance copper alloy (Phosphor Bronze & Brass)

Finish: (a) Contact Area: Gold plated based on order information

- (b) Under plate: Nickel-plated all over
- (c) Solder area: Tin plated
- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp.
- 4.2.3 Shell: Stainless steel

#### 4.3 Ratings

- 4.3.1 Voltage: 30 Volts AC (per pin)
- 4.3.2 Current: 1.8 A FOR PIN 1 AND PIN 4

0.25A FOR ALL THE OTHER CONTACTS

4.3.3 Operating Temperature : -55°C to +85°C



TITLE: USB 3.0 A TYPE

RELEASE DATE: 2021.07.28 REVISION: B **ECN No:** ECN-003171 PAGE: **5** OF **9** 

#### 5 Performance

## 5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard					
Examination of	Product shall meet requirements	Visual, dimensional and functional per					
Product	of applicable product drawing and	applicable quality inspection plan.					
	specification.	A.					
	ELECTRIC						
ltem	Requirement	Standard					
Low Level Contact Resistance	$30~m\Omega$ (Max) initial for VBUS and GND contacts. $50~m\Omega$ (Max) initial for all other contacts. $40~m\Omega$ (Max) after for VBUS and GND contacts. $60~m\Omega$ (Max) after for all other contacts.	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)					
Insulation Resistance	100 M Ω Min.	Unmated and mated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)					
Dielectric	No discharge, flashover or	100 VAC Min. at sea level for 1 minute.					
withstanding	breakdown.	Test between adjacent contacts of					
voltage	Current leakage: 1 mA max.	unmated and mated connectors. (EIA-364-20)					
Temperature rise	30℃ Max. Change allowed	A current of 1.8 A shall be applied to VBUS pin and its corresponding GND pin. Additionally, a minimum current of 0.25 A shall be applied to all tile other contacts. when measured at an ambient temperature of 25 °C. (EIA-364-70 METHOD 2)					
	90Ω +/-15Ω	Mated connector 50 ps (20%-80%)					
Differential Impedance	Reefer to High Frequency Graphic Figure 1	Risetime.					
	MECHANIC	CAL					
Item	Requirement	Standard					
Durability	5000 cycles.	The durability test shall be done at a maximum rate of 200 cycles per hour and no physical damage to any part of the connector and cable assembly shall occur. (EIA-364-09)					
Insertion / Extraction Force	Insertion Force: 35 N Max. Extraction Force: 10 N Min. Initial 8 N Min. Final	Operation Speed:  12.5 ± 3 mm/minute.  Measure the force required to mate/unmate connector.  (EIA-364-13)					



TITLE: USB 3.0 A TYPE

Solder ability

RELEASE DATE: 2021.07.28 | REVISION: B | ECN No: ECN-003171 | PAGE: 6 OF 9

Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)					
	ENVIRONMI	ENTAL					
Item	Requirement	Standard					
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 8	Pre Heat: 150°C ~180°C, 60~120sec. Heat: 230°C Min., 40sec Min. Peak Temp.: 260°C Max, 10sec Max. (EIA-364-56)					
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, Test condition I)					
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 90~95% RH,96 hours. (EIA-364-31,Condition A, Method II)					
Temperature life	See Product Qualification and Test Sequence Group 5	Subject mated connectors to temperature life at 105°C for 96 hours. (EIA-364-17, Test condition A)					
Salt Spray	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II) Au 30u" for 48 hours (EIA-364-26)					
		<u> </u>					

Note. Flowing Mixed Gas shell be conduct by customer request.

Solder able area shall have

minimum of 95% solder coverage.

And then into solder bath, Temperature at

245 ±5°C, for 5 sec.

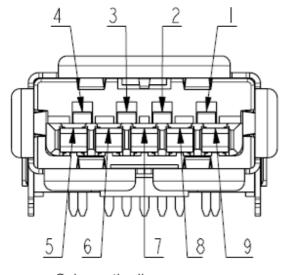
(EIA-364-52)



TITLE: USB 3.0 A TYPE

RELEASE DATE: 2021.07.28 | REVISION: B | ECN No: ECN-003171 | PAGE: 7 OF 9

#### 6 PIN ASSIGNMENTS

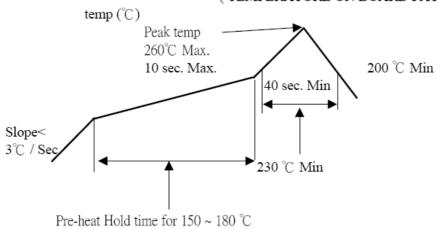


Pin Number	Signal Name				
1	VBUS				
2	D-				
3	D+				
4	GND				
5	StdA_SSRX-				
6	StdA_SSRX+				
7	GND_DRAIN				
8	StdA_SSTX-				
9	StdA_SSTX+				
Shell	Shield				

Schematic diagram

### 7 INFRARED REFLOW CONDITION

# TEMPERATURE CONDITION GRAPH ( TEMPERATURE ON BOARD PATTERN SIDE )



Pre-heat Hold time for  $150 \sim 180 ^{\circ}$ C is  $60 \sim 120$  sec.



TITLE: USB 3.0 A TYPE

RELEASE DATE: 2021.07.28 REVISION: B **ECN No:** ECN-003171 PAGE: **8** OF **9** 

## 8 PRODUCT QUALIFICATION AND TEST SEQUENCE

	Test Group										
Test or Examination	1	2	3	4	5	6	7	8	9	10	
		Test Sequence									
Examination of Product				1 . 7	1、6	1 \ 4		1			
Low Level Contact Resistance		1 \ 5	1 \ 3	2 \ 10	2 \ 9	2 ` 5		3			
Insulation Resistance				3 . 9	3、8						
Dielectric Withstanding Voltage				4 \ 8	4 \ 7						
Temperature rise											
Insertion / Extraction Force		2 · 4									
Durability		3									
Vibration			2								
Thermal Shock				5							
Humidity				6							
Temperature life					5						
Salt Spray						3					
Solder ability							1				
Resistance to Soldering Heat								2			
Sample Size	2	4	4	4	4	4	2	4			

TITLE: USB 3.0 A TYPE

RELEASE DATE: 2021.07.28 | REVISION: B | ECN No: ECN-003171 | PAGE: 9 OF 9

#### 9 HIGH FREQUENCY GRAPHIC

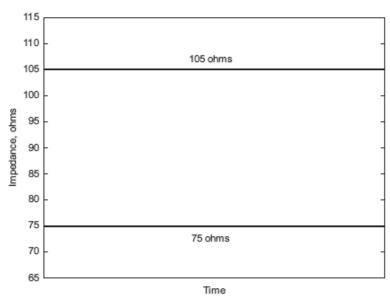


Figure 1
Impedance Limits of a Mated Connector